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What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Obsolete
Core Processor	PIC
Core Size	16-Bit
Speed	60 MIPS
Connectivity	I ² C, IrDA, LINbus, QEI, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, DMA, Motor Control PWM, POR, PWM, WDT
Number of I/O	21
Program Memory Size	32KB (10.7K x 24)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	2K x 16
Voltage - Supply (Vcc/Vdd)	3V ~ 3.6V
Data Converters	A/D 6x10b/12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 150°C (TA)
Mounting Type	Through Hole
Package / Case	28-DIP (0.300", 7.62mm)
Supplier Device Package	28-SPDIP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic24ep32mc202-h-sp

3.6 CPU Resources

Many useful resources are provided on the main product page of the Microchip web site for the devices listed in this data sheet. This product page, which can be accessed using this link, contains the latest updates and additional information.

Note: In the event you are not able to access the product page using the link above, enter this URL in your browser: http://www.microchip.com/wwwproducts/Devices.aspx?dDocName=en555464
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3.6.1 KEY RESOURCES

- “CPU” (DS70359) in the “*dsPIC33/PIC24 Family Reference Manual*”
- Code Samples
- Application Notes
- Software Libraries
- Webinars
- All related “*dsPIC33/PIC24 Family Reference Manual*” Sections
- Development Tools

TABLE 4-14: PWM GENERATOR 2 REGISTER MAP FOR dsPIC33EPXXXMC20X/50X AND PIC24EPXXXMC20X DEVICES ONLY

File Name	Addr.	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets	
PWMCON2	0C40	FLTSTAT	CLSTAT	TRGSTAT	FLTIE	CLIE	TRGIE	ITB	MDCS	DTC<1:0>		DTCP	—	MTBS	CAM	XPRES	IUE	0000	
IOCON2	0C42	PENH	PENL	POLH	POLL	PMOD<1:0>		OVRENH	OVRENL	OVRDAT<1:0>		FLTDAT<1:0>		CLDAT<1:0>		SWAP	OSYNC	C000	
FCLCON2	0C44	—	CLSRC<4:0>					CLPOL	CLMOD	FLTSRC<4:0>					FLTPOL	FLTMOD<1:0>		00F8	
PDC2	0C46	PDC2<15:0>																	0000
PHASE2	0C48	PHASE2<15:0>																	0000
DTR2	0C4A	—	—	DTR2<13:0>														0000	
ALTDTR2	0C4C	—	—	ALTDTR2<13:0>														0000	
TRIG2	0C52	TRGCMP<15:0>																	0000
TRGCON2	0C54	TRGDIV<3:0>				—	—	—	—	—	—	TRGSTRT<5:0>							0000
LEBCON2	0C5A	PHR	PHF	PLR	PLF	FLTLEBEN	CLLEBEN	—	—	—	—	BCH	BCL	BPHH	BPHL	BPLH	BPLL	0000	
LEBDLY2	0C5C	—	—	—	—	LEB<11:0>												0000	
AUXCON2	0C5E	—	—	—	—	BLANKSEL<3:0>				—	—	CHOPSEL<3:0>				CHOPHEN	CHOPLN	0000	

Legend: — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

TABLE 4-15: PWM GENERATOR 3 REGISTER MAP FOR dsPIC33EPXXXMC20X/50X AND PIC24EPXXXMC20X DEVICES ONLY

File Name	Addr.	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets	
PWMCON3	0C60	FLTSTAT	CLSTAT	TRGSTAT	FLTIE	CLIE	TRGIE	ITB	MDCS	DTC<1:0>		DTCP	—	MTBS	CAM	XPRES	IUE	0000	
IOCON3	0C62	PENH	PENL	POLH	POLL	PMOD<1:0>		OVRENH	OVRENL	OVRDAT<1:0>		FLTDAT<1:0>		CLDAT<1:0>		SWAP	OSYNC	C000	
FCLCON3	0C64	—	CLSRC<4:0>					CLPOL	CLMOD	FLTSRC<4:0>					FLTPOL	FLTMOD<1:0>		00F8	
PDC3	0C66	PDC3<15:0>																	0000
PHASE3	0C68	PHASE3<15:0>																	0000
DTR3	0C6A	—	—	DTR3<13:0>														0000	
ALTDTR3	0C6C	—	—	ALTDTR3<13:0>														0000	
TRIG3	0C72	TRGCMP<15:0>																	0000
TRGCON3	0C74	TRGDIV<3:0>				—	—	—	—	—	—	TRGSTRT<5:0>							0000
LEBCON3	0C7A	PHR	PHF	PLR	PLF	FLTLEBEN	CLLEBEN	—	—	—	—	BCH	BCL	BPHH	BPHL	BPLH	BPLL	0000	
LEBDLY3	0C7C	—	—	—	—	LEB<11:0>												0000	
AUXCON3	0C7E	—	—	—	—	BLANKSEL<3:0>				—	—	CHOPSEL<3:0>				CHOPHEN	CHOPLEN	0000	

Legend: — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

TABLE 4-20: ADC1 REGISTER MAP

File Name	Addr.	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets	
ADC1BUF0	0300	ADC1 Data Buffer 0																	xxxx
ADC1BUF1	0302	ADC1 Data Buffer 1																	xxxx
ADC1BUF2	0304	ADC1 Data Buffer 2																	xxxx
ADC1BUF3	0306	ADC1 Data Buffer 3																	xxxx
ADC1BUF4	0308	ADC1 Data Buffer 4																	xxxx
ADC1BUF5	030A	ADC1 Data Buffer 5																	xxxx
ADC1BUF6	030C	ADC1 Data Buffer 6																	xxxx
ADC1BUF7	030E	ADC1 Data Buffer 7																	xxxx
ADC1BUF8	0310	ADC1 Data Buffer 8																	xxxx
ADC1BUF9	0312	ADC1 Data Buffer 9																	xxxx
ADC1BUFA	0314	ADC1 Data Buffer 10																	xxxx
ADC1BUFB	0316	ADC1 Data Buffer 11																	xxxx
ADC1BUFC	0318	ADC1 Data Buffer 12																	xxxx
ADC1BUFD	031A	ADC1 Data Buffer 13																	xxxx
ADC1BUFE	031C	ADC1 Data Buffer 14																	xxxx
ADC1BUFF	031E	ADC1 Data Buffer 15																	xxxx
AD1CON1	0320	ADON	—	ADSIDL	ADDMABM	—	AD12B	FORM<1:0>	SSRC<2:0>			SSRCG	SIMSAM	ASAM	SAMP	DONE	0000		
AD1CON2	0322	VCFG<2:0>			—	—	CSCNA	CHPS<1:0>	BUFS	SMPI<4:0>						BUFM	ALTS	0000	
AD1CON3	0324	ADRC	—	—	SAMC<4:0>				ADCS<7:0>									0000	
AD1CHS123	0326	—	—	—	—	—	CH123NB<1:0>		CH123SB	—	—	—	—	—	CH123NA<1:0>		CH123SA	0000	
AD1CHS0	0328	CH0NB	—	—	CH0SB<4:0>				CH0NA	—	—	CH0SA<4:0>						0000	
AD1CSSH	032E	CSS31	CSS30	—	—	—	CSS26	CSS25	CSS24	—	—	—	—	—	—	—	—	0000	
AD1CSSL	0330	CSS15	CSS14	CSS13	CSS12	CSS11	CSS10	CSS9	CSS8	CSS7	CSS6	CSS5	CSS4	CSS3	CSS2	CSS1	CSS0	0000	
AD1CON4	0332	—	—	—	—	—	—	—	ADDMAEN	—	—	—	—	—	DMABL<2:0>			0000	

Legend: x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

REGISTER 8-3: DMAxSTAH: DMA CHANNEL x START ADDRESS REGISTER A (HIGH)

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 15				bit 8			

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
STA<23:16>							
bit 7				bit 0			

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'
-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-8 **Unimplemented:** Read as '0'
bit 7-0 **STA<23:16>:** Primary Start Address bits (source or destination)

REGISTER 8-4: DMAxSTAL: DMA CHANNEL x START ADDRESS REGISTER A (LOW)

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
STA<15:8>							
bit 15				bit 8			

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
STA<7:0>							
bit 7				bit 0			

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'
-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-0 **STA<15:0>:** Primary Start Address bits (source or destination)

REGISTER 11-22: RPOR4: PERIPHERAL PIN SELECT OUTPUT REGISTER 4

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	RP43R<5:0>					
bit 15							bit 8

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	RP42R<5:0>					
bit 7							bit 0

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 15-14 **Unimplemented:** Read as '0'bit 13-8 **RP43R<5:0>**: Peripheral Output Function is Assigned to RP43 Output Pin bits
(see Table 11-3 for peripheral function numbers)bit 7-6 **Unimplemented:** Read as '0'bit 5-0 **RP42R<5:0>**: Peripheral Output Function is Assigned to RP42 Output Pin bits
(see Table 11-3 for peripheral function numbers)**REGISTER 11-23: RPOR5: PERIPHERAL PIN SELECT OUTPUT REGISTER 5**

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	RP55R<5:0>					
bit 15							bit 8

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	RP54R<5:0>					
bit 7							bit 0

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 15-14 **Unimplemented:** Read as '0'bit 13-8 **RP55R<5:0>**: Peripheral Output Function is Assigned to RP55 Output Pin bits
(see Table 11-3 for peripheral function numbers)bit 7-6 **Unimplemented:** Read as '0'bit 5-0 **RP54R<5:0>**: Peripheral Output Function is Assigned to RP54 Output Pin bits
(see Table 11-3 for peripheral function numbers)

NOTES:

REGISTER 16-3: PTPER: PWMx PRIMARY MASTER TIME BASE PERIOD REGISTER

R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
PTPER<15:8>							
bit 15				bit 8			

R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-0	R/W-0	R/W-0
PTPER<7:0>							
bit 7				bit 0			

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 15-0 **PTPER<15:0>**: Primary Master Time Base (PMTMR) Period Value bits**REGISTER 16-4: SEVTCMP: PWMx PRIMARY SPECIAL EVENT COMPARE REGISTER**

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
SEVTCMP<15:8>							
bit 15				bit 8			

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
SEVTCMP<7:0>							
bit 7				bit 0			

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 15-0 **SEVTCMP<15:0>**: Special Event Compare Count Value bits

REGISTER 17-7: VEL1CNT: VELOCITY COUNTER 1 REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
VELCNT<15:8>							
bit 15				bit 8			

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
VELCNT<7:0>							
bit 7				bit 0			

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'
 -n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-0 **VELCNT<15:0>**: Velocity Counter bits

REGISTER 17-8: INDX1CNTH: INDEX COUNTER 1 HIGH WORD REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
INDXCNT<31:24>							
bit 15				bit 8			

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
INDXCNT<23:16>							
bit 7				bit 0			

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'
 -n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-0 **INDXCNT<31:16>**: High Word Used to Form 32-Bit Index Counter Register (INDX1CNT) bits

REGISTER 17-9: INDX1CNTL: INDEX COUNTER 1 LOW WORD REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
INDXCNT<15:8>							
bit 15				bit 8			

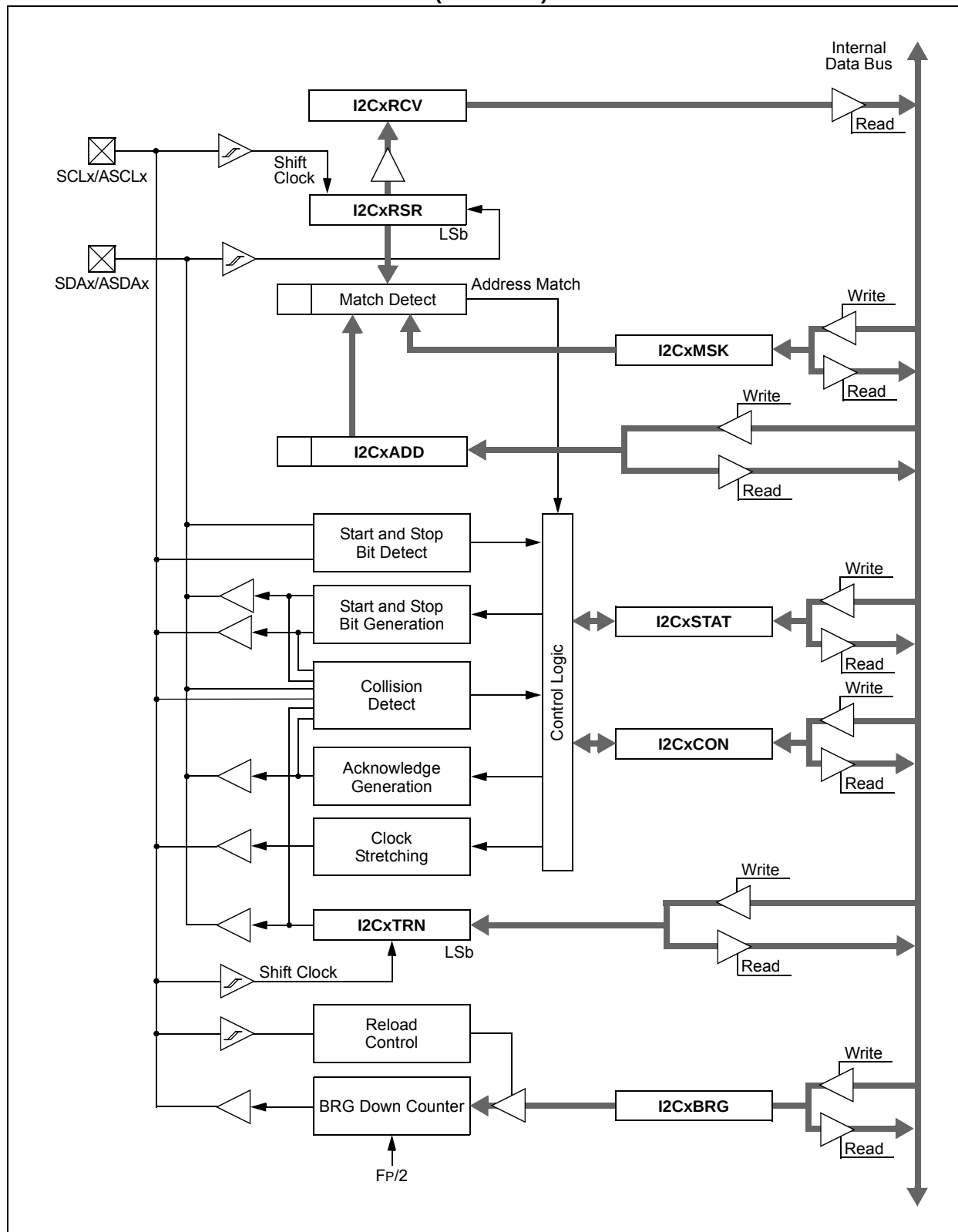
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
INDXCNT<7:0>							
bit 7				bit 0			

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'
 -n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-0 **INDXCNT<15:0>**: Low Word Used to Form 32-Bit Index Counter Register (INDX1CNT) bits

FIGURE 19-1: I2Cx BLOCK DIAGRAM (x = 1 OR 2)



REGISTER 23-4: AD1CON4: ADC1 CONTROL REGISTER 4

U-0	U-0	U-0	U-0	U-0	U-0	U-0	R/W-0
—	—	—	—	—	—	—	ADDMAEN
bit 15							bit 8

U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0
—	—	—	—	—	DMABL2	DMABL1	DMABL0
bit 7							bit 0

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 15-9

Unimplemented: Read as '0'

bit 8

ADDMAEN: ADC1 DMA Enable bit

1 = Conversion results are stored in the ADC1BUF0 register for transfer to RAM using DMA

0 = Conversion results are stored in ADC1BUF0 through ADC1BUFF registers; DMA will not be used

bit 7-3

Unimplemented: Read as '0'

bit 2-0

DMABL<2:0>: Selects Number of DMA Buffer Locations per Analog Input bits

111 = Allocates 128 words of buffer to each analog input

110 = Allocates 64 words of buffer to each analog input

101 = Allocates 32 words of buffer to each analog input

100 = Allocates 16 words of buffer to each analog input

011 = Allocates 8 words of buffer to each analog input

010 = Allocates 4 words of buffer to each analog input

001 = Allocates 2 words of buffer to each analog input

000 = Allocates 1 word of buffer to each analog input

REGISTER 23-8: AD1CSSL: ADC1 INPUT SCAN SELECT REGISTER LOW^(1,2)

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
CSS15	CSS14	CSS13	CSS12	CSS11	CSS10	CSS9	CSS8
bit 15						bit 8	

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
CSS7	CSS6	CSS5	CSS4	CSS3	CSS2	CSS1	CSS0
bit 7						bit 0	

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'
 -n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-0 **CSS<15:0>:** ADC1 Input Scan Selection bits
 1 = Selects ANx for input scan
 0 = Skips ANx for input scan

- Note 1:** On devices with less than 16 analog inputs, all AD1CSSL bits can be selected by the user. However, inputs selected for scan, without a corresponding input on the device, convert VREFL.
- 2:** CSSx = ANx, where x = 0-15.

27.0 SPECIAL FEATURES

Note: This data sheet summarizes the features of the dsPIC33EPXXXGP50X, dsPIC33EPXXXMC20X/50X and PIC24EPXXXGP/MC20X families of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to the related section of the “dsPIC33/PIC24 Family Reference Manual”, which is available from the Microchip web site (www.microchip.com).

dsPIC33EPXXXGP50X, dsPIC33EPXXXMC20X/50X and PIC24EPXXXGP/MC20X devices include several features intended to maximize application flexibility and reliability, and minimize cost through elimination of external components. These are:

- Flexible Configuration
- Watchdog Timer (WDT)
- Code Protection and CodeGuard™ Security
- JTAG Boundary Scan Interface
- In-Circuit Serial Programming™ (ICSP™)
- In-Circuit Emulation

27.1 Configuration Bits

In dsPIC33EPXXXGP50X, dsPIC33EPXXXMC20X/50X and PIC24EPXXXGP/MC20X devices, the Configuration bytes are implemented as volatile memory. This means that configuration data must be programmed each time the device is powered up. Configuration data is stored in at the top of the on-chip program memory space, known as the Flash Configuration bytes. Their specific locations are shown in Table 27-1. The configuration data is automatically loaded from the Flash Configuration bytes to the proper Configuration Shadow registers during device Resets.

Note: Configuration data is reloaded on all types of device Resets.

When creating applications for these devices, users should always specifically allocate the location of the Flash Configuration bytes for configuration data in their code for the compiler. This is to make certain that program code is not stored in this address when the code is compiled.

The upper 2 bytes of all Flash Configuration Words in program memory should always be ‘1111 1111 1111 1111’. This makes them appear to be NOP instructions in the remote event that their locations are ever executed by accident. Since Configuration bits are not implemented in the corresponding locations, writing ‘1’s to these locations has no effect on device operation.

Note: Performing a page erase operation on the last page of program memory clears the Flash Configuration bytes, enabling code protection as a result. Therefore, users should avoid performing page erase operations on the last page of program memory.

The Configuration Flash bytes map is shown in Table 27-1.

29.0 DEVELOPMENT SUPPORT

The PIC® microcontrollers (MCU) and dsPIC® digital signal controllers (DSC) are supported with a full range of software and hardware development tools:

- Integrated Development Environment
 - MPLAB® X IDE Software
- Compilers/Assemblers/Linkers
 - MPLAB XC Compiler
 - MPASM™ Assembler
 - MPLINK™ Object Linker/
MPLIB™ Object Librarian
 - MPLAB Assembler/Linker/Librarian for
Various Device Families
- Simulators
 - MPLAB X SIM Software Simulator
- Emulators
 - MPLAB REAL ICE™ In-Circuit Emulator
- In-Circuit Debuggers/Programmers
 - MPLAB ICD 3
 - PICKit™ 3
- Device Programmers
 - MPLAB PM3 Device Programmer
- Low-Cost Demonstration/Development Boards,
Evaluation Kits and Starter Kits
- Third-party development tools

29.1 MPLAB X Integrated Development Environment Software

The MPLAB X IDE is a single, unified graphical user interface for Microchip and third-party software, and hardware development tool that runs on Windows®, Linux and Mac OS® X. Based on the NetBeans IDE, MPLAB X IDE is an entirely new IDE with a host of free software components and plug-ins for high-performance application development and debugging. Moving between tools and upgrading from software simulators to hardware debugging and programming tools is simple with the seamless user interface.

With complete project management, visual call graphs, a configurable watch window and a feature-rich editor that includes code completion and context menus, MPLAB X IDE is flexible and friendly enough for new users. With the ability to support multiple tools on multiple projects with simultaneous debugging, MPLAB X IDE is also suitable for the needs of experienced users.

Feature-Rich Editor:

- Color syntax highlighting
- Smart code completion makes suggestions and provides hints as you type
- Automatic code formatting based on user-defined rules
- Live parsing

User-Friendly, Customizable Interface:

- Fully customizable interface: toolbars, toolbar buttons, windows, window placement, etc.
- Call graph window

Project-Based Workspaces:

- Multiple projects
- Multiple tools
- Multiple configurations
- Simultaneous debugging sessions

File History and Bug Tracking:

- Local file history feature
- Built-in support for Bugzilla issue tracker

30.0 ELECTRICAL CHARACTERISTICS

This section provides an overview of dsPIC33EPXXXGP50X, dsPIC33EPXXXMC20X/50X and PIC24EPXXXGP/MC20X electrical characteristics. Additional information will be provided in future revisions of this document as it becomes available.

Absolute maximum ratings for the dsPIC33EPXXXGP50X, dsPIC33EPXXXMC20X/50X and PIC24EPXXXGP/MC20X family are listed below. Exposure to these maximum rating conditions for extended periods may affect device reliability. Functional operation of the device at these or any other conditions above the parameters indicated in the operation listings of this specification is not implied.

Absolute Maximum Ratings⁽¹⁾

Ambient temperature under bias	-40°C to +125°C
Storage temperature	-65°C to +150°C
Voltage on VDD with respect to VSS	-0.3V to +4.0V
Voltage on any pin that is not 5V tolerant, with respect to VSS ⁽³⁾	-0.3V to (VDD + 0.3V)
Voltage on any 5V tolerant pin with respect to VSS when VDD ≥ 3.0V ⁽³⁾	-0.3V to +5.5V
Voltage on any 5V tolerant pin with respect to VSS when VDD < 3.0V ⁽³⁾	-0.3V to +3.6V
Maximum current out of VSS pin	300 mA
Maximum current into VDD pin ⁽²⁾	300 mA
Maximum current sunk/sourced by any 4x I/O pin	15 mA
Maximum current sunk/sourced by any 8x I/O pin	25 mA
Maximum current sunk by all ports ^(2,4)	200 mA

Note 1: Stresses above those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only, and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

2: Maximum allowable current is a function of device maximum power dissipation (see Table 30-2).

3: See the “Pin Diagrams” section for the 5V tolerant pins.

4: Exceptions are: dsPIC33EPXXXGP502, dsPIC33EPXXXMC202/502 and PIC24EPXXXGP/MC202 devices, which have a maximum sink/source capability of 130 mA.

FIGURE 30-11: TIMERQ (QEI MODULE) EXTERNAL CLOCK TIMING CHARACTERISTICS
(dsPIC33EPXXXMC20X/50X AND PIC24EPXXXMC20X DEVICES ONLY)

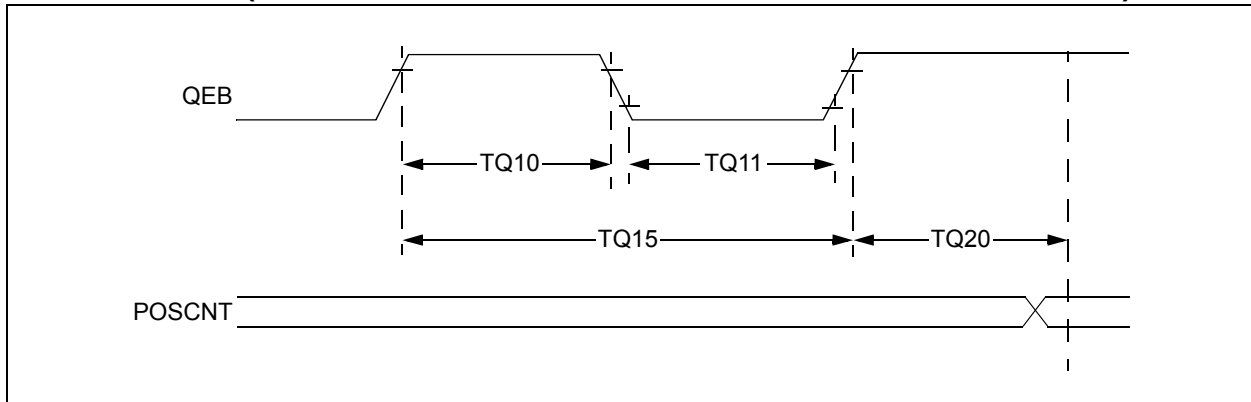


TABLE 30-30: QEI MODULE EXTERNAL CLOCK TIMING REQUIREMENTS
(dsPIC33EPXXXMC20X/50X AND PIC24EPXXXMC20X DEVICES ONLY)

AC CHARACTERISTICS				Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ for Industrial $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$ for Extended				
Param No.	Symbol	Characteristic ⁽¹⁾		Min.	Typ.	Max.	Units	Conditions
TQ10	TtQH	TQCK High Time	Synchronous, with prescaler	Greater of $12.5 + 25$ or $(0.5 T_{CY}/N) + 25$	—	—	ns	Must also meet Parameter TQ15
TQ11	TtQL	TQCK Low Time	Synchronous, with prescaler	Greater of $12.5 + 25$ or $(0.5 T_{CY}/N) + 25$	—	—	ns	Must also meet Parameter TQ15
TQ15	TtQP	TQCP Input Period	Synchronous, with prescaler	Greater of $25 + 50$ or $(1 T_{CY}/N) + 50$	—	—	ns	
TQ20	TCKEXTMRL	Delay from External TQCK Clock Edge to Timer Increment		—	1	T_{CY}	—	

Note 1: These parameters are characterized but not tested in manufacturing.

FIGURE 30-13: QEI MODULE INDEX PULSE TIMING CHARACTERISTICS
(dsPIC33EPXXXMC20X/50X and PIC24EPXXXMC20X DEVICES ONLY)

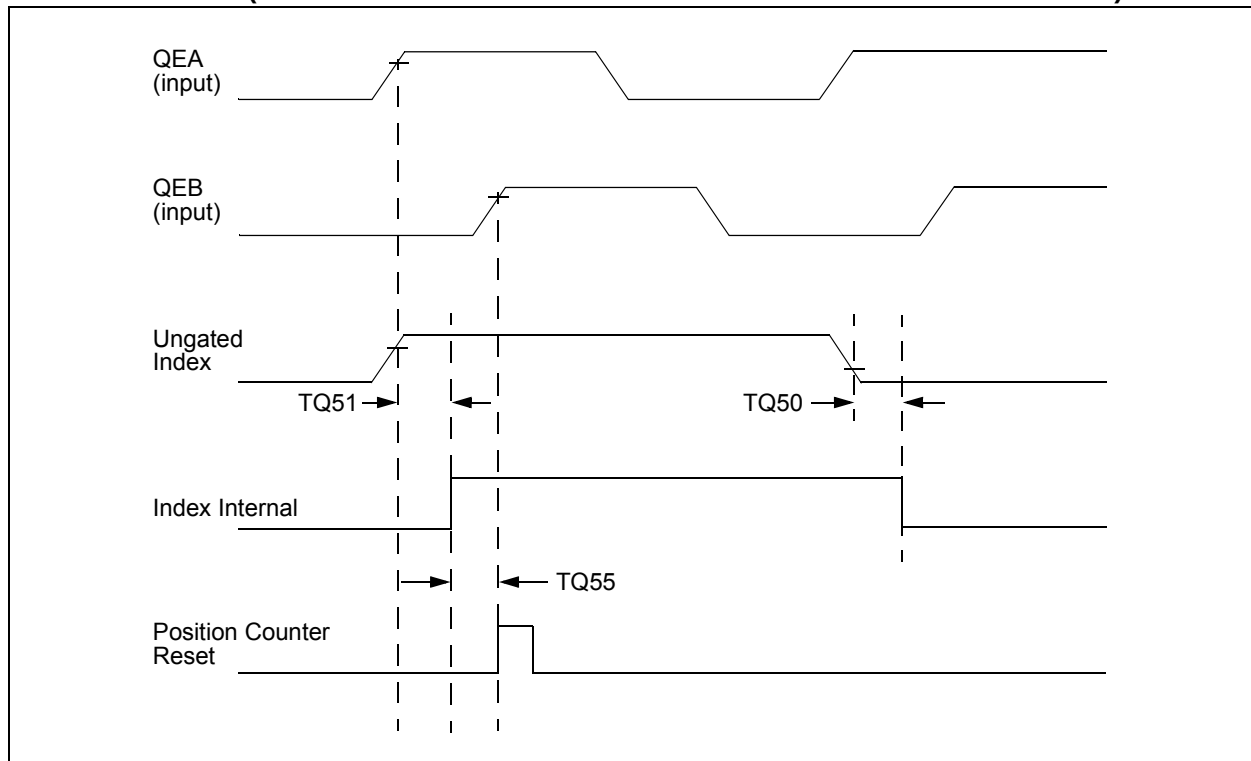


TABLE 30-32: QEI INDEX PULSE TIMING REQUIREMENTS
(dsPIC33EPXXXMC20X/50X and PIC24EPXXXMC20X DEVICES ONLY)

AC CHARACTERISTICS			Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ for Industrial $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$ for Extended			
Param No.	Symbol	Characteristic ⁽¹⁾	Min.	Max.	Units	Conditions
TQ50	TqiL	Filter Time to Recognize Low, with Digital Filter	$3 * N * T_{CY}$	—	ns	$N = 1, 2, 4, 16, 32, 64, 128$ and 256 (Note 2)
TQ51	TqiH	Filter Time to Recognize High, with Digital Filter	$3 * N * T_{CY}$	—	ns	$N = 1, 2, 4, 16, 32, 64, 128$ and 256 (Note 2)
TQ55	Tqidxr	Index Pulse Recognized to Position Counter Reset (ungated index)	$3 T_{CY}$	—	ns	

Note 1: These parameters are characterized but not tested in manufacturing.

2: Alignment of index pulses to QEA and QEB is shown for position counter Reset timing only. Shown for forward direction only (QEA leads QEB). Same timing applies for reverse direction (QEA lags QEB) but index pulse recognition occurs on the falling edge.

**FIGURE 30-21: SPI2 SLAVE MODE (FULL-DUPLEX, CKE = 0, CKP = 0, SMP = 0)
TIMING CHARACTERISTICS**

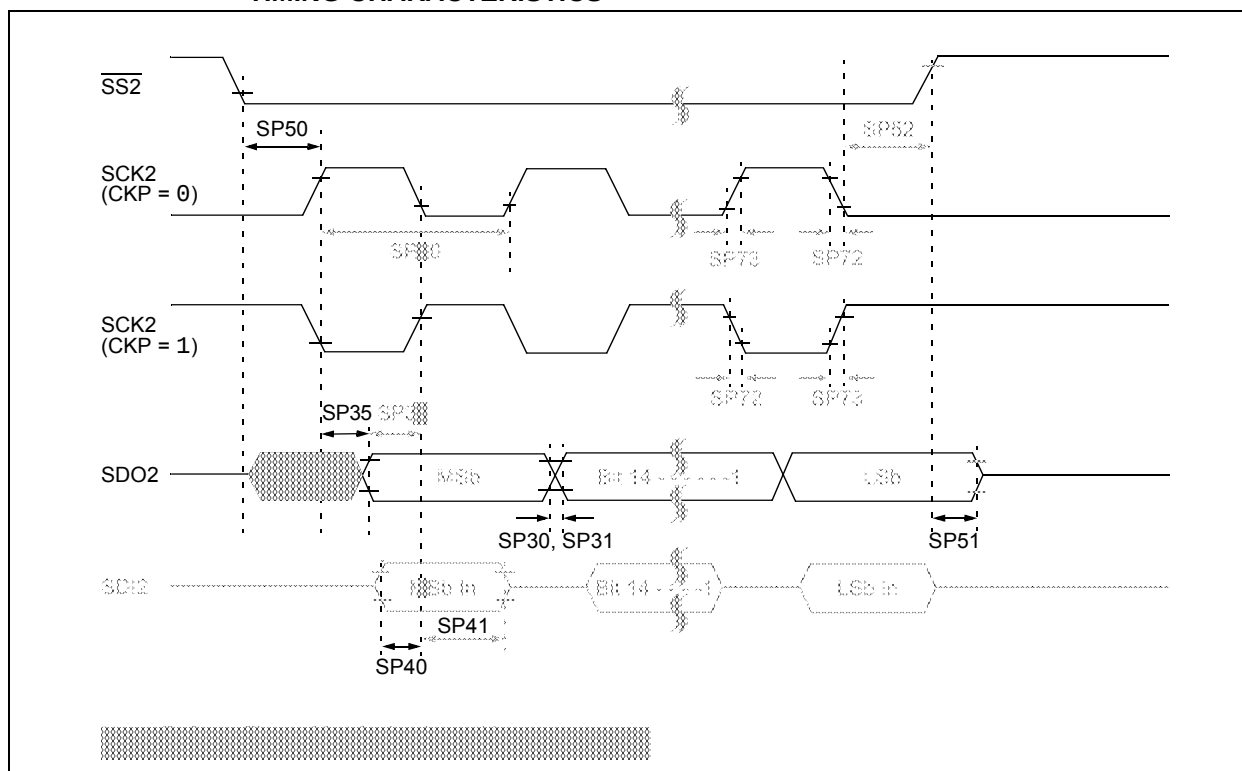


TABLE 30-53: OP AMP/COMPARATOR SPECIFICATIONS (CONTINUED)

DC CHARACTERISTICS			Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) ⁽¹⁾ Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended				
Param No.	Symbol	Characteristic	Min.	Typ. ⁽²⁾	Max.	Units	Conditions
Op Amp DC Characteristics							
CM40	VCMR	Common-Mode Input Voltage Range	AVSS	—	AVDD	V	
CM41	CMRR	Common-Mode Rejection Ratio ⁽³⁾	—	40	—	db	VCM = AVDD/2
CM42	VOFFSET	Op Amp Offset Voltage ⁽³⁾	—	±5	—	mV	
CM43	VGAIN	Open-Loop Voltage Gain ⁽³⁾	—	90	—	db	
CM44	IOS	Input Offset Current	—	—	—	—	See pad leakage currents in Table 30-11
CM45	IB	Input Bias Current	—	—	—	—	See pad leakage currents in Table 30-11
CM46	IOUT	Output Current	—	—	420	μA	With minimum value of RFEEDBACK (CM48)
CM48	RFEEDBACK	Feedback Resistance Value	8	—	—	kΩ	
CM49a	VOADC	Output Voltage Measured at OAx Using ADC ^(3,4)	AVSS + 0.077 AVSS + 0.037 AVSS + 0.018	— — —	AVDD – 0.077 AVDD – 0.037 AVDD – 0.018	V V V	IOUT = 420 μA IOUT = 200 μA IOUT = 100 μA
CM49b	VOOUT	Output Voltage Measured at OAxOUT Pin ^(3,4,5)	AVSS + 0.210 AVSS + 0.100 AVSS + 0.050	— — —	AVDD – 0.210 AVDD – 0.100 AVDD – 0.050	V V V	IOUT = 420 μA IOUT = 200 μA IOUT = 100 μA
CM51	RINT1 ⁽⁶⁾	Internal Resistance 1 (Configuration A and B) ^(3,4,5)	198	264	317	Ω	Min = -40°C Typ = +25°C Max = +125°C

Note 1: Device is functional at VBORMIN < VDD < VDDMIN, but will have degraded performance. Device functionality is tested, but not characterized. Analog modules (ADC, op amp/comparator and comparator voltage reference) may have degraded performance. Refer to Parameter BO10 in Table 30-13 for the minimum and maximum BOR values.

2: Data in “Typ” column is at 3.3V, +25°C unless otherwise stated.

3: Parameter is characterized but not tested in manufacturing.

4: See Figure 25-6 for configuration information.

5: See Figure 25-7 for configuration information.

6: Resistances can vary by ±10% between op amps.

FIGURE 30-37: ADC CONVERSION (10-BIT MODE) TIMING CHARACTERISTICS
(CHPS<1:0> = 01, SIMSAM = 0, ASAM = 0, SSRG<2:0> = 000, SSRG = 0)

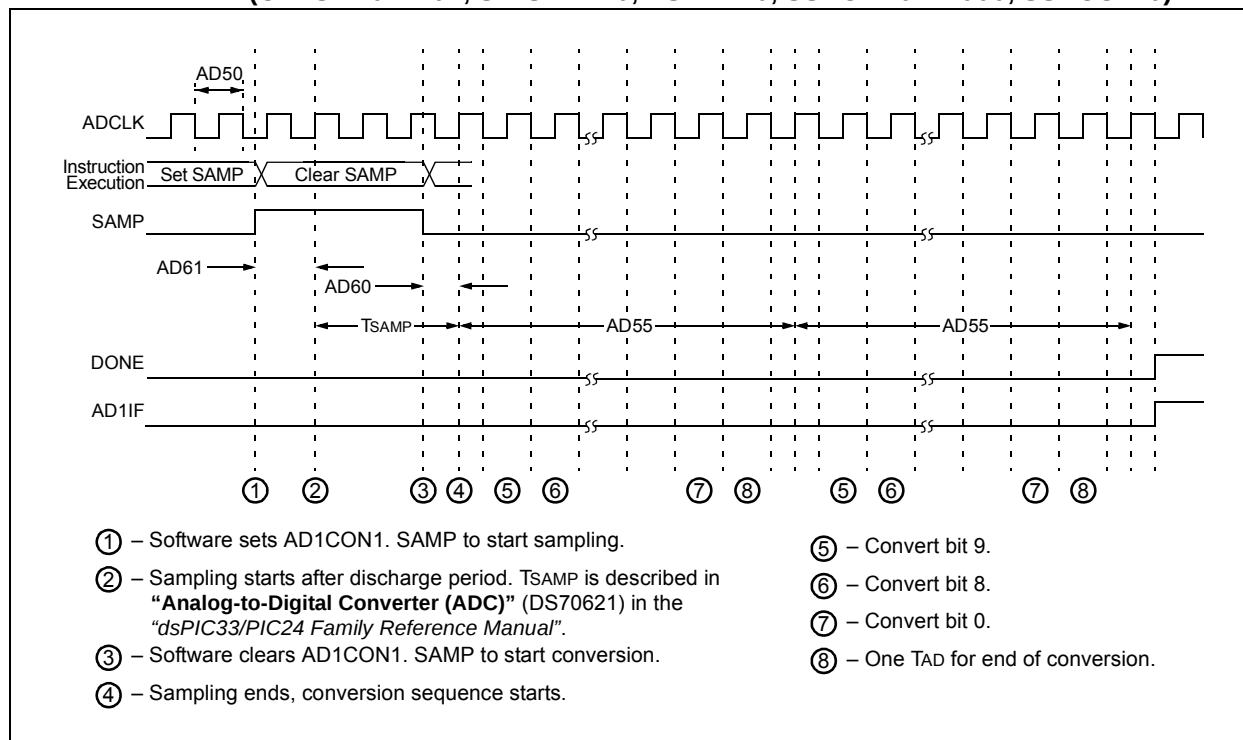
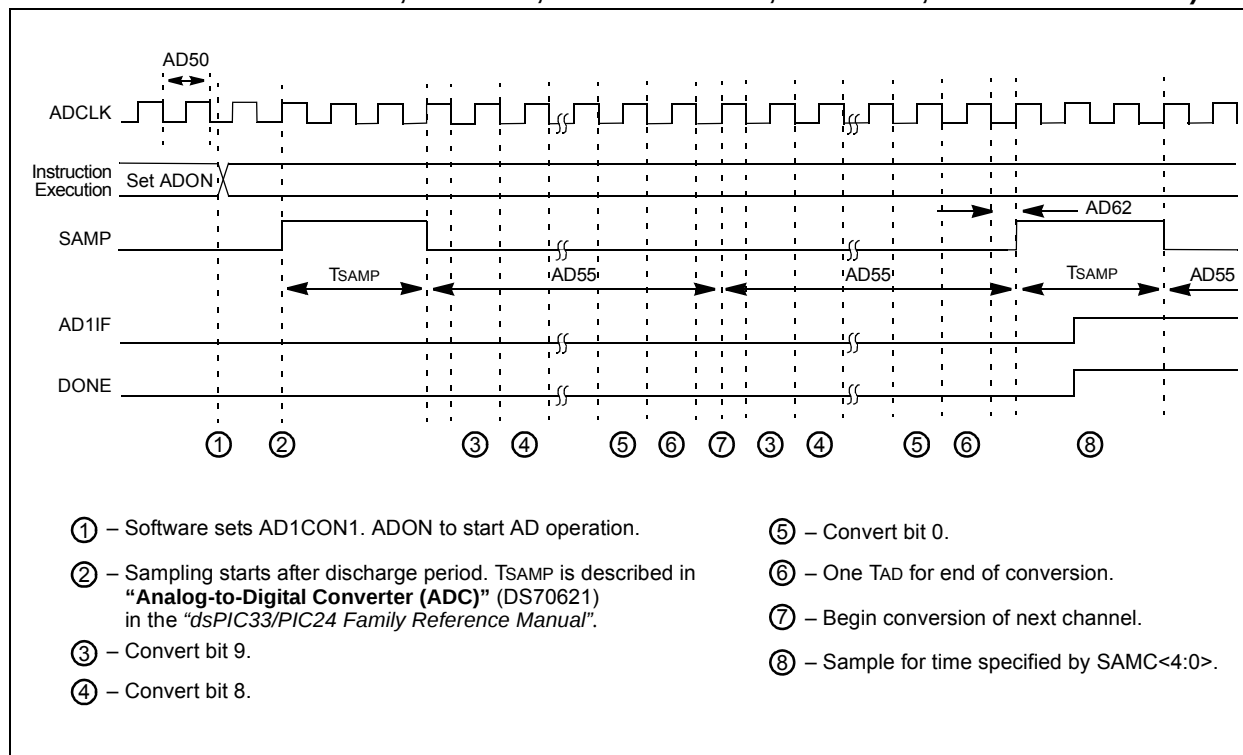


FIGURE 30-38: ADC CONVERSION (10-BIT MODE) TIMING CHARACTERISTICS (CHPS<1:0> = 01, SIMSAM = 0, ASAM = 1, SSRG<2:0> = 111, SSRG = 0, SAMC<4:0> = 00010)



DMAxSTA _H (DMA Channel x Start Address A, High)	144	PTGCST (PTG Control/Status).....	340
DMAxSTAL (DMA Channel x Start Address A, Low)	144	PTGHOLD (PTG Hold)	347
DMAxSTBH (DMA Channel x Start Address B, High)	145	PTGL0 (PTG Literal 0).....	348
DMAxSTBL (DMA Channel x Start Address B, Low)	145	PTGQPTR (PTG Step Queue Pointer)	349
DSADRH (DMA Most Recent RAM High Address)	147	PTGQUE _x (PTG Step Queue x)	349
DSADRL (DMA Most Recent RAM Low Address)	147	PTGSDLIM (PTG Step Delay Limit)	346
DTR _x (PWM _x Dead-Time)	238	PTGT0LIM (PTG Timer0 Limit).....	345
FCLCON _x (PWM _x Fault Current-Limit Control)	243	PTGT1LIM (PTG Timer1 Limit).....	345
I2CxCON (I2Cx Control)	276	PTPER (PWM _x Primary Master Time Base Period).....	233
I2CxMSK (I2Cx Slave Mode Address Mask)	280	PWMCON _x (PWM _x Control).....	235
I2CxSTAT (I2Cx Status)	278	QE1CON (QE1 Control)	252
ICxCON1 (Input Capture x Control 1)	215	QE1GECH (QE1 Greater Than or Equal Compare High Word).....	262
ICxCON2 (Input Capture x Control 2)	216	QE1GECL (QE1 Greater Than or Equal Compare Low Word)	262
INDX1CNTH (Index Counter 1 High Word)	259	QE1ICH (QE1 Initialization/Capture High Word)	260
INDX1CNTL (Index Counter 1 Low Word)	259	QE1ICL (QE1 Initialization/Capture Low Word)	260
INDX1HLD (Index Counter 1 Hold)	260	QE1IOC (QE1 I/O Control)	254
INT1HLDH (Interval 1 Timer Hold High Word).....	264	QE1LECH (QE1 Less Than or Equal Compare High Word).....	261
INT1HLDL (Interval 1 Timer Hold Low Word)	264	QE1LECL (QE1 Less Than or Equal Compare Low Word)	261
INT1TMRH (Interval 1 Timer High Word).....	263	QE1STAT (QE1 Status).....	256
INT1TMRL (Interval 1 Timer Low Word).....	263	RCON (Reset Control).....	125
INTCON1 (Interrupt Control 1)	134	REFOCON (Reference Oscillator Control)	162
INTCON2 (Interrupt Control 2)	136	RPINR0 (Peripheral Pin Select Input 0).....	183
INTCON2 (Interrupt Control 3).....	137	RPINR1 (Peripheral Pin Select Input 1).....	184
INTCON4 (Interrupt Control 4).....	137	RPINR11 (Peripheral Pin Select Input 11).....	187
INTTREG (Interrupt Control and Status).....	138	RPINR12 (Peripheral Pin Select Input 12).....	188
IOCON _x (PWM _x I/O Control)	240	RPINR14 (Peripheral Pin Select Input 14).....	189
LEBCON _x (PWM _x Leading-Edge Blanking Control)	245	RPINR15 (Peripheral Pin Select Input 15).....	190
LEBDLY _x (PWM _x Leading-Edge Blanking Delay).....	246	RPINR18 (Peripheral Pin Select Input 18).....	191
MDC (PWM _x Master Duty Cycle).....	234	RPINR19 (Peripheral Pin Select Input 19).....	191
NVMADRH (Nonvolatile Memory Address High)	122	RPINR22 (Peripheral Pin Select Input 22).....	192
NVMADRL (Nonvolatile Memory Address Low).....	122	RPINR23 (Peripheral Pin Select Input 23).....	193
NVMCON (Nonvolatile Memory (NVM) Control)	121	RPINR26 (Peripheral Pin Select Input 26).....	193
NVMKEY (Nonvolatile Memory Key)	122	RPINR3 (Peripheral Pin Select Input 3).....	184
OCxCON1 (Output Compare x Control 1)	221	RPINR37 (Peripheral Pin Select Input 37).....	194
OCxCON2 (Output Compare x Control 2)	223	RPINR38 (Peripheral Pin Select Input 38).....	195
OSCCON (Oscillator Control)	156	RPINR39 (Peripheral Pin Select Input 39).....	196
OSCTUN (FRC Oscillator Tuning)	161	RPINR7 (Peripheral Pin Select Input 7).....	185
PDC _x (PWM _x Generator Duty Cycle)	237	RPINR8 (Peripheral Pin Select Input 8).....	186
PHASE _x (PWM _x Primary Phase-Shift)	237	RPOR0 (Peripheral Pin Select Output 0).....	197
PLLFB _D (PLL Feedback Divisor)	160	RPOR1 (Peripheral Pin Select Output 1).....	197
PMD1 (Peripheral Module Disable Control 1)	166	RPOR2 (Peripheral Pin Select Output 2).....	198
PMD2 (Peripheral Module Disable Control 2).....	168	RPOR3 (Peripheral Pin Select Output 3).....	198
PMD3 (Peripheral Module Disable Control 3).....	169	RPOR4 (Peripheral Pin Select Output 4).....	199
PMD4 (Peripheral Module Disable Control 4).....	169	RPOR5 (Peripheral Pin Select Output 5).....	199
PMD6 (Peripheral Module Disable Control 6).....	170	RPOR6 (Peripheral Pin Select Output 6).....	200
PMD7 (Peripheral Module Disable Control 7).....	171	RPOR7 (Peripheral Pin Select Output 7).....	200
POS1CNTH (Position Counter 1 High Word)	258	RPOR8 (Peripheral Pin Select Output 8).....	201
POS1CNTL (Position Counter1 Low Word)	258	RPOR9 (Peripheral Pin Select Output 9).....	201
POS1HLD (Position Counter 1 Hold)	258	SEVTCMP (PWM _x Primary Special Event Compare)	233
PTCON (PWM _x Time Base Control)	230	SPIxCON1 (SPI _x Control 1).....	270
PTCON2 (PWM _x Primary Master Clock Divider Select 2).....	232	SPIxCON2 (SPI _x Control 2).....	272
PTGADJ (PTG Adjust)	348	SPIxSTAT (SPI _x Status and Control)	268
PTGBTE (PTG Broadcast Trigger Enable)	343	SR (CPU STATUS).....	40, 132
PTGC0LIM (PTG Counter 0 Limit)	346	T1CON (Timer1 Control)	205
PTGC1LIM (PTG Counter 1 Limit)	347	TRGCON _x (PWM _x Trigger Control)	239
PTGCON (PTG Control)	342	TRIG _x (PWM _x Primary Trigger Compare Value).....	242
		TxCON (Timer2 and Timer4 Control)	210